

TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO-FLOW UNDERFILL AND METHODS OF MANUFACTURE

INVENTORS NAME: Carlos A. Gonzalez et al. SERIAL NO.: 10/003238

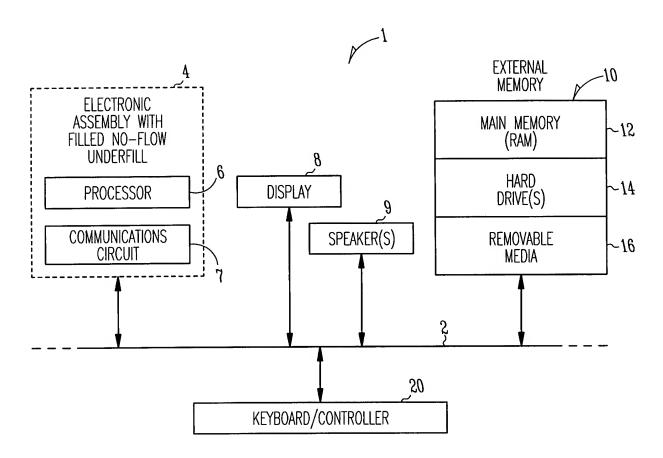
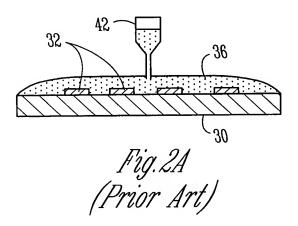


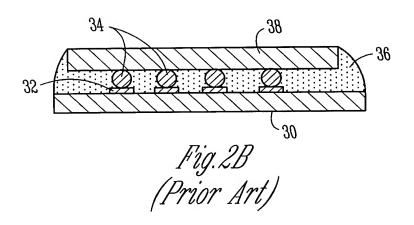
Fig. 1

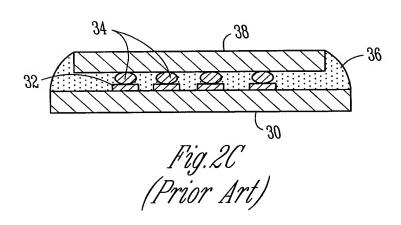


TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO-FLOW UNDERFILL AND METHODS OF MANUFACTURE INVENTORS NAME: Carlos A. Gonzalez et al.

SERIAL NO.: 10/003238



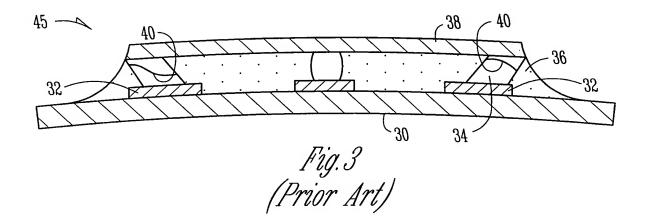


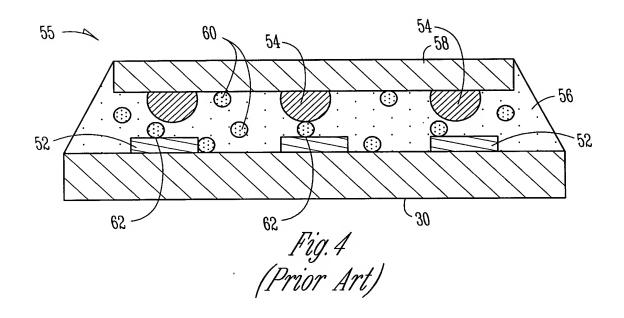


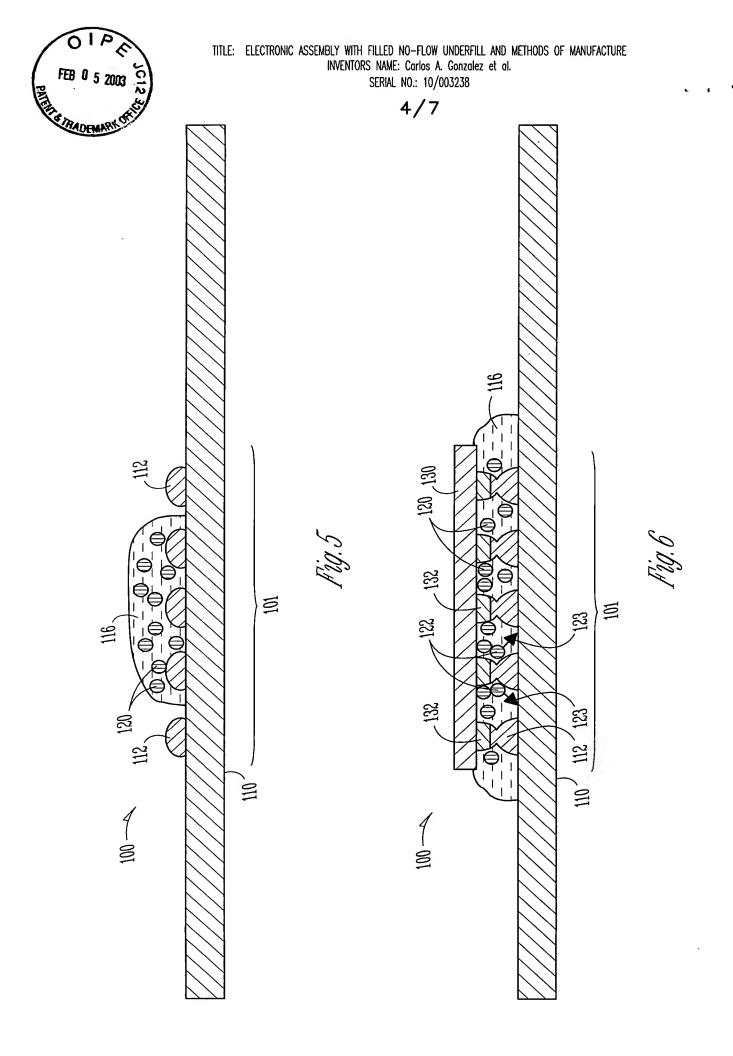


TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO-FLOW UNDERFILL AND METHODS OF MANUFACTURE

INVENTORS NAME; Carlos A. Gonzalez et al. SERIAL NO.: 10/003238



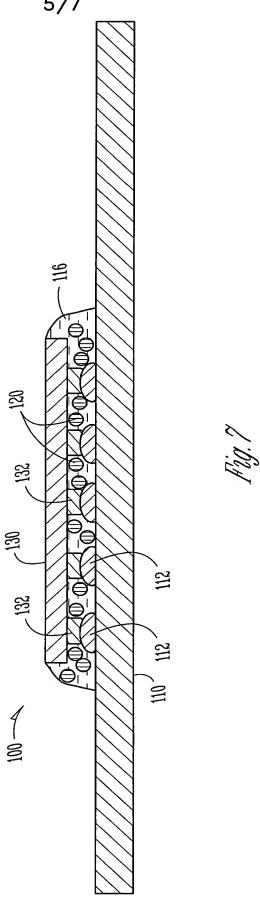






TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO-FLOW UNDERFILL AND METHODS OF MANUFACTURE INVENTORS NAME: Carlos A. Gonzalez et al.

SERIAL NO.: 10/003238





TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO-FLOW UNDERFILL AND METHODS OF MANUFACTURE INVENTORS NAME: Carlos A. Gonzalez et al.

SERIAL NO.: 10/003238

6/7

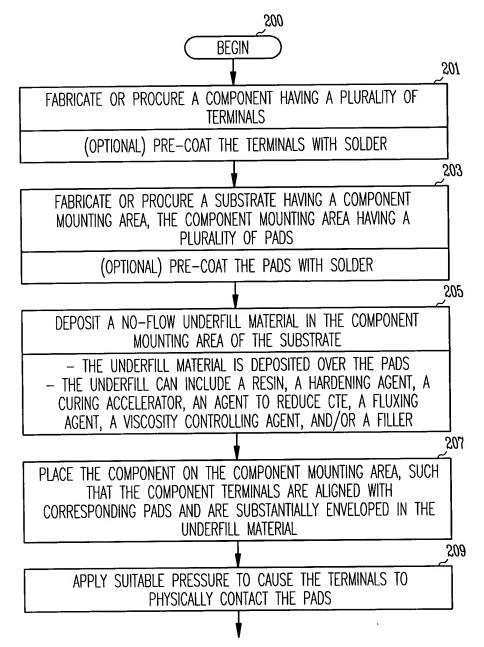


Fig. 8A



TITLE: ELECTRONIC ASSEMBLY WITH FILLED NO—FLOW UNDERFILL AND METHODS OF MANUFACTURE INVENTORS NAME: Carlos A. Gonzalez et al.

SERIAL NO.: 10/003238

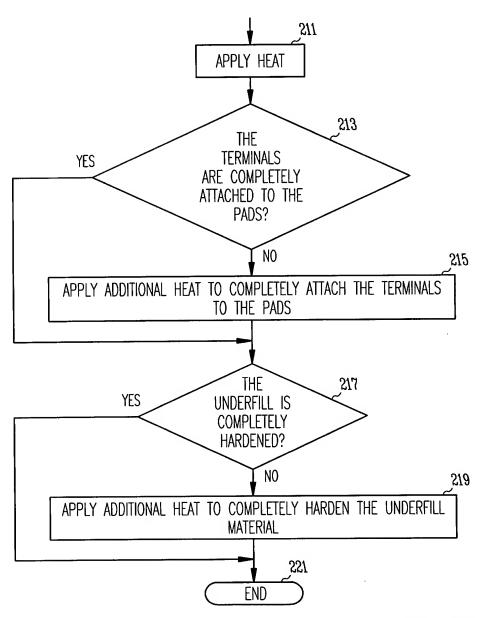


Fig.8B